

GOTECH "the best partner" to raise your competition

GT-6014-B MIT式耐折強度試驗機 MIT FOLDING ENDURANCE TESTER

本機適用於測試軟性電路板MIT式耐折強度，以一定的張力左右各135度往復回轉運動，搭配可設定測試件導電斷路停機條件，停機條件約設定值±10%，以判別其耐折強度。

GT-6014-B is designed to determine the resistance of flexible printed circuit board to folding. During test, the specimen is folded at 135° repeatedly. The impedance of the specimen is measured.



彎曲速度 Speed	90cpm、175cpm
彎曲角度 Folding angle	135° or 90°
折疊頭寬度 Width of folding head	19mm
折口圓弧半徑 Arc radius of folding surface	0.38mm
折疊頭夾縫距離 Clamping thickness of folding head	0.25mm · 0.5mm · 0.75mm · 1.0mm · 1.25mm
體積 Dimension(W×D×H)	45×30×50 cm
重量(約) Weight(approx.)	40 kg
電源 Power	1φ · AC220V · 50/60Hz (依國別或指定 or specify)

瞭解更多產品資訊，請登錄我司網站 www.gotech.biz